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ProLight PBLB-5LTE-RGBN 5W 4 in 1 RGBN Power LED Technical Datasheet Version: 2.3

# **ProLight Opto ProEngine Series**

### Features

- · Compact light source
- $\cdot$  R, G, B, N four color in one package
- $\cdot$  Maximum drive current: 400mA per LED die
- $\cdot$  Lead free reflow soldering
- · RoHS compliant

# **Main Applications**

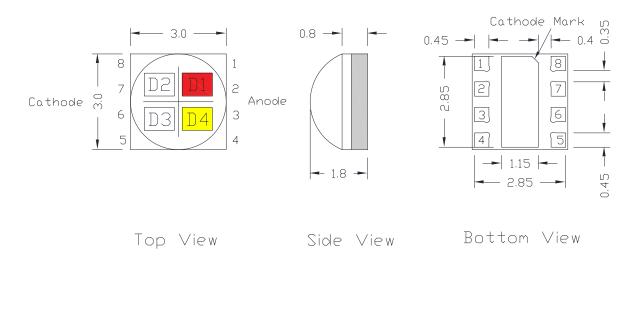
- · Entertainment lighting (Stage lighting)
- · Architectural lighting
- $\cdot \operatorname{Mood} \operatorname{lighting}$
- $\cdot$  Outdoor lighting
- $\cdot$  Indoor lighting

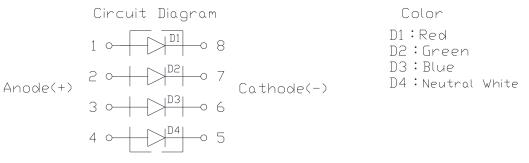
#### Introduction

 ProLight PBLB colorful series is a color changeable LED with maximum 4 color chips in one package. Compared to discrete LEDs, PBLB series reduce the distance between LED die, creating a small optical source for excellent optical control and efficient color mixing. ProLight PBLB series is much suitable for the application of color-changing lighting, especially for entertainment lighting.



#### **Emitter Mechanical Dimensions**





Notes:

- 1. Drawing not to scale.
- 2. All dimensions are in millimeters.
- 3. Unless otherwise indicated, tolerances are  $\pm\,0.15\text{mm}.$
- 4. Please do not solder the emitter by manual hand soldering, otherwise it will damage the emitter.
- 5. Please do not use a force of over 1kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

\*The appearance and specifications of the product may be modified for improvement without notice.



# Flux Characteristics at 350mA, T<sub>J</sub> = 25°C

|               | Part Number     | Luminous F | CRI     |         |
|---------------|-----------------|------------|---------|---------|
| Color         | Emitter         | Minimum    | Typical | Minimum |
| Red           |                 | 45         | 55      | -       |
| Green         | PBLB-5LTE-RGBN  | 90         | 115     | -       |
| Blue          | PBLB-3LTE-RGBIN | 14         | 18.5    | -       |
| Neutral White |                 | 68         | 92      | 80      |

• ProLight maintains a tolerance of ± 7% on flux and power measurements.

• Please do not drive at rated current more than 1 second without proper heat sink.

# Electrical Characteristics at 350mA, T<sub>J</sub> = 25°C

|               | Forward Voltage V <sub>F</sub> (V) |      |      | Thermal Resistance      |
|---------------|------------------------------------|------|------|-------------------------|
| Color         | Min.                               | Тур. | Max. | Junction to Slug (°C/W) |
| Red           | 1.9                                | 2.3  | 2.7  |                         |
| Green         | 2.8                                | 3.3  | 3.7  | 10                      |
| Blue          | 2.8                                | 3.3  | 3.7  | 10                      |
| Neutral White | 2.8                                | 3.3  | 3.7  |                         |

• ProLight maintains a tolerance of ± 0.1V for Voltage measurements.

# Optical Characteristics at 350mA, $T_J = 25^{\circ}C$

| Radiation  | Color         |        | nant Waveleng<br>or Temperatu |        | Total<br>included<br>Angle<br>(degrees) | Viewing<br>Angle<br>(degrees) |
|------------|---------------|--------|-------------------------------|--------|---|-------------------------------|
| Pattern    | Color         | Min.   | Тур.                          | Max.   | θ <sub>0.90V</sub>                      | <b>2 θ</b> <sub>1/2</sub>     |
|            | Red           | 619 nm | 622 nm                        | 629 nm |   |                               |
| Lambertian | Green         | 520 nm | 525 nm                        | 530 nm | 170                                     | 455                           |
| Lampentian | Blue          | 449 nm | 452 nm                        | 455 nm |   | 155                           |
|            | Neutral White | 3700 K | 3950 K                        | 4250 K |   |                               |

• ProLight maintains a tolerance of ± 1nm for dominant wavelength measurements.

• ProLight maintains a tolerance of ± 5% for CCT measurements.



# **Absolute Maximum Ratings**

| Parameter  | Red/Green/Blue/Neutral White              |
|--|---|
| DC Forward Current (mA)                                      | 400                                       |
| Peak Pulsed Forward Current (mA)                             | 500 (less than 1/10 duty cycle@1KHz)      |
| ESD Sensitivity<br>(HBM per MIL-STD-883E Method 3015.7)      | > ±500V                                   |
| LED Junction Temperature                                     | 120°C                                     |
| Operating Board Temperature<br>at Maximum DC Forward Current | -40°C - 85°C                              |
| Storage Temperature  | -40°C - 120°C                             |
| Soldering Temperature  | JEDEC 020c 260°C                          |
| Allowable Reflow Cycles                                      | 3   |
| Reverse Voltage  | Not designed to be driven in reverse bias |

#### **Photometric Luminous Flux Bin Structure**

| Color         | Bin Code | Minimum<br>Photometric Flux (Im) | Maximum<br>Photometric Flux (Im) |
|---------------|----------|----------------------------------|----------------------------------|
| Red           | A        | 45                               | 58                               |
|               | B        | 58                               | 75                               |
| Green         | A        | 90                               | 115                              |
|               | B        | 115                              | 147                              |
| Blue          | A        | 14                               | 18.5                             |
|               | B        | 18.5                             | 24.5                             |
| Neutral White | A        | 68                               | 92                               |
|               | B        | 92                               | 112                              |

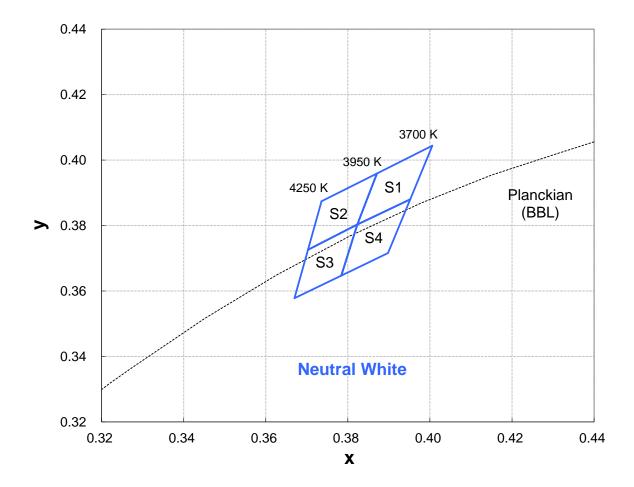
 $\bullet$  ProLight maintains a tolerance of  $\pm$  7% on flux and power measurements.

• The flux bin of the product may be modified for improvement without notice.



# **Color Bin**

Neutral White Binning Structure Graphical Representation



#### **Neutral White Bin Structure**

| Bin Code | x      | У      | Typ. CCT<br>(K) | Bin Code | x      | У      | Typ. CCT<br>(K) |
|----------|--------|--------|-----------------|----------|--------|--------|-----------------|
|          | 0.3871 | 0.3959 |                 |          | 0.3736 | 0.3874 |                 |
| S1       | 0.4006 | 0.4044 | 3825            | S2       | 0.3871 | 0.3959 | 4100            |
| 51       | 0.3952 | 0.3880 | 3020            | 52       | 0.3823 | 0.3803 | 4100            |
|          | 0.3823 | 0.3803 |                 |          | 0.3703 | 0.3726 |                 |
|          | 0.3823 | 0.3803 |                 |          | 0.3703 | 0.3726 |                 |
| S4       | 0.3952 | 0.3880 | 3825            | S3       | 0.3823 | 0.3803 | 4100            |
| 54       | 0.3898 | 0.3716 |                 | 00       | 0.3784 | 0.3647 | 4100            |
|          | 0.3784 | 0.3647 |                 |          | 0.3670 | 0.3578 |                 |
|          |        |        |                 |          |        |        |                 |

• Tolerance on each color bin (x , y) is ± 0.005



#### **Dominant Wavelength Bin Structure**

| Color | Bin Code | Minimum Dominant<br>Wavelength (nm) | Maximum Dominant<br>Wavelength (nm) |
|-------|----------|-------------------------------------|-------------------------------------|
| Red   | 4        | 619                                 | 629                                 |
| Green | 1        | 520                                 | 530                                 |
| Blue  | A        | 449                                 | 455                                 |

• ProLight maintains a tolerance of ± 1nm for dominant wavelength measurements.

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

#### **Forward Voltage Bin Structure**

| Color         | Bin Code | Minimum Voltage (V) | Maximum Voltage (V) |
|---------------|----------|---------------------|---------------------|
| Red           | 0        | 1.9                 | 2.7                 |
| Green         | 0        | 2.8                 | 3.7                 |
| Blue          | 0        | 2.8                 | 3.7                 |
| Neutral White | 0        | 2.8                 | 3.7                 |

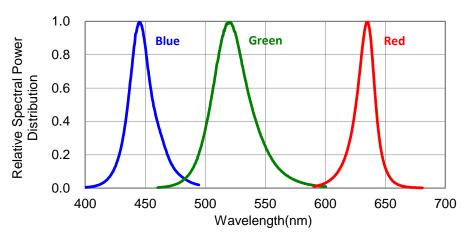
• ProLight maintains a tolerance of  $\pm$  0.1V for Voltage measurements.

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

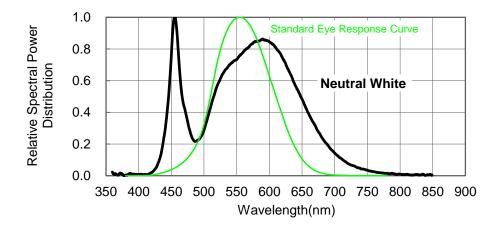


# Color Spectrum, $T_j = 25^{\circ}C$

1. Blue Sreen Red



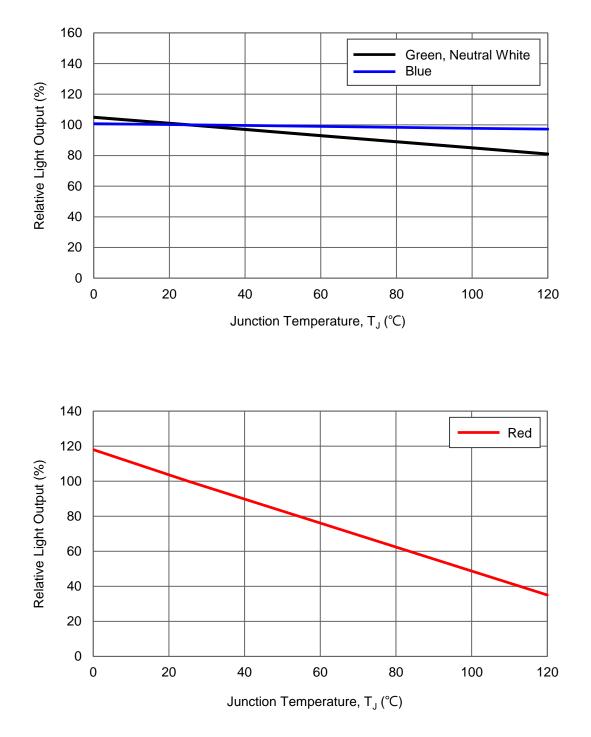
2. Neutral White





# **Light Output Characteristics**

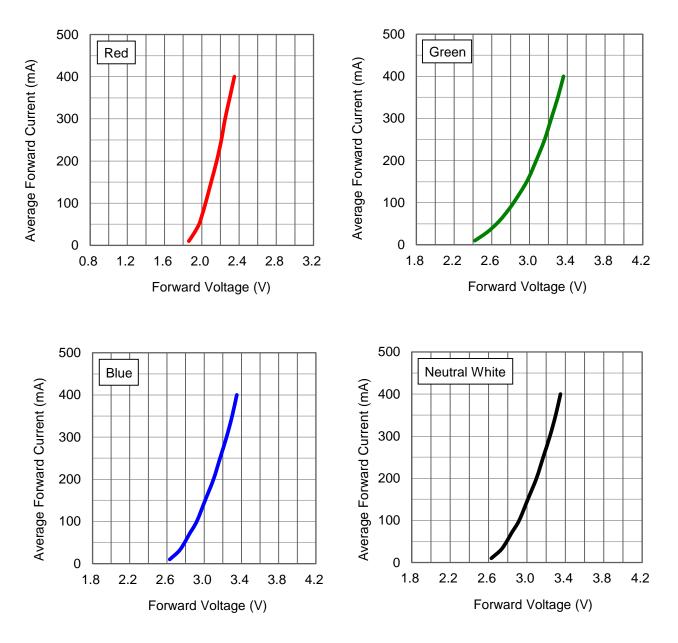
Relative Light Output vs. Junction Temperature at 400mA





# Forward Current Characteristics, $T_1 = 25^{\circ}C$

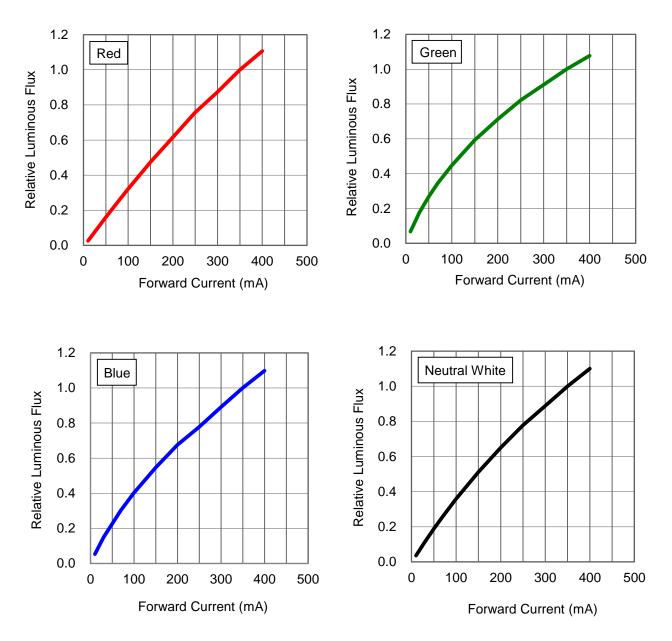
1. Forward Voltage vs. Forward Current





# Forward Current Characteristics, T<sub>J</sub> = 25°C

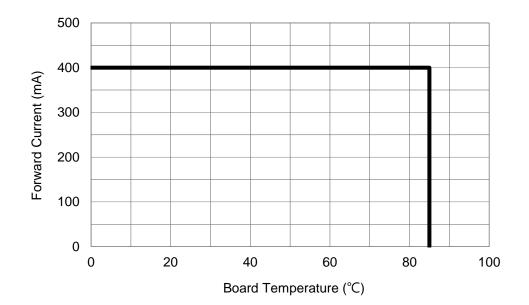
2. Forward Current vs. Normalized Relative Luminous Flux



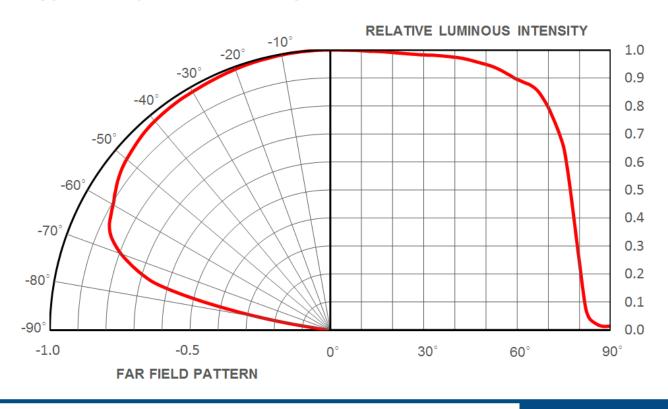


#### **Board Temperature vs. Maximum Forward Current**

Maximum Forward Current for 4 chip operated



#### **Typical Representative Spatial Radiation Pattern**





### **Moisture Sensitivity Level - JEDEC Level 1**

|       |           |                                | Soak Requirements |                  |              |             |  |
|-------|-----------|--------------------------------|-------------------|------------------|--------------|-------------|--|
| Level | Floo      | r Life                         | Stan              | dard             | Accelerated  | Environment |  |
|       | Time      | Conditions                     | Time (hours)      | Conditions       | Time (hours) | Conditions  |  |
| 1     | Unlimited | ≤30 <sup>°</sup> C /<br>85% RH | 168 +5/-0         | 85°C /<br>85% RH | NA           | NA          |  |

- The standard soak time includes a default value of 24 hours for semiconductor manufature's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

|       |                        |                                |                        | Soak Req         | uirements               |                  |
|-------|------------------------|--------------------------------|------------------------|------------------|-------------------------|------------------|
| Level | Floor Life             |                                | Stan                   | dard             | Accelerated Environment |                  |
|       | Time                   | Conditions                     | Time (hours)           | Conditions       | Time (hours)            | Conditions       |
| 1     | Unlimited              | ≤30 <sup>°</sup> C /<br>85% RH | 168 +5/-0              | 85°C /<br>85% RH | NA                      | NA               |
| 2     | 1 year                 | ≤30°C /<br>60% RH              | 168 +5/-0              | 85°C /<br>60% RH | NA                      | NA               |
| 2a    | 4 weeks                | ≤30°C /<br>60% RH              | 696 +5/-0              | 30°C /<br>60% RH | 120 +1/-0               | 60°C /<br>60% RH |
| 3     | 168 hours              | ≤30°C /<br>60% RH              | 192 +5/-0              | 30°C /<br>60% RH | 40 +1/-0                | 60°C /<br>60% RH |
| 4     | 72 hours               | ≤30°C /<br>60% RH              | 96 +2/-0               | 30°C /<br>60% RH | 20 +0.5/-0              | 60°C /<br>60% RH |
| 5     | 48 hours               | ≤30°C /<br>60% RH              | 72 +2/-0               | 30°C /<br>60% RH | 15 +0.5/-0              | 60°C /<br>60% RH |
| 5a    | 24 hours               | ≤30°C /<br>60% RH              | 48 +2/-0               | 30°C /<br>60% RH | 10 +0.5/-0              | 60°C /<br>60% RH |
| 6     | Time on Label<br>(TOL) | ≤30°C /<br>60% RH              | Time on Label<br>(TOL) | 30°C /<br>60% RH | NA                      | NA               |



# **Qualification Reliability Testing**

| Stress Test                                  | Stress Conditions  | Stress<br>Duration | Failure Criteria           |
|--|--|--------------------|----------------------------|
| Room Temperature<br>Operating Life (RTOL)    | 25°C, I <sub>F</sub> = max DC (Note 1)   | 1000 hours         | Note 2                     |
| Wet High Temperature<br>Storage Life (WHTSL) | 85°C/85%RH, non-operating  | 1000 hours         | Note 2                     |
| High Temperature<br>Storage Life (HTSL)      | 110°C, non-operating   | 1000 hours         | Note 2                     |
| Low Temperature<br>Storage Life (LTSL)       | -40°C, non-operating   | 1000 hours         | Note 2                     |
| Non-operating<br>Temperature Cycle (TMCL)    | -40°C to 120°C, 30 min. dwell,<br><5 min. transfer                             | 200 cycles         | Note 2                     |
| Mechanical Shock                             | 1500 G, 0.5 msec. pulse,<br>5 shocks each 6 axis                               |                    | Note 3                     |
| Natural Drop                                 | On concrete from 1.2 m, 3X   |                    | Note 3                     |
| Variable Vibration<br>Frequency              | 10-2000-10 Hz, log or linear sweep rate,<br>20 G about 1 min., 1.5 mm, 3X/axis |                    | Note 3                     |
| Solder Heat Resistance<br>(SHR)              | 260°C ± 5°C, 10 sec.   |                    | Note 3                     |
| Solderability                                | Steam age for 16 hrs., then solder dip<br>at 260°C for 5 sec.                  |                    | Solder coverage<br>on lead |

Notes:

- 1. Depending on the maximum derating curve.
- 2. Criteria for judging failure

| Item   | Test Condition          | Criteria for Judgement |                     |  |
|--|-------------------------|------------------------|---------------------|--|
| nem  | Test Condition          | Min.                   | Max.                |  |
| Forward Voltage (V <sub>F</sub> )                  | I <sub>F</sub> = max DC |                        | Initial Level x 1.1 |  |
| Luminous Flux or<br>Radiometric Power ( $\Phi_V$ ) | I <sub>F</sub> = max DC | Initial Level x 0.7    |                     |  |
| Reverse Current (I <sub>R</sub> )                  | $V_R = 5V$              |                        | 50 µA               |  |

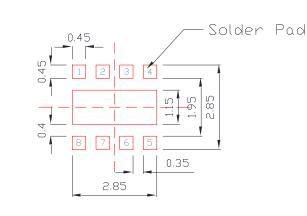
\* The test is performed after the LED is cooled down to the room temperature.

3. A failure is an LED that is open or shorted.

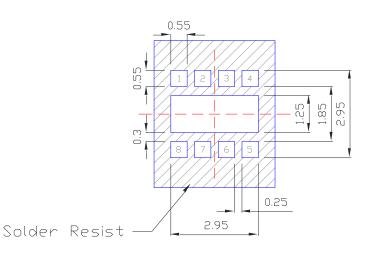


## **Recommended Solder Pad Design**

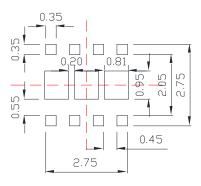




#### **Solder Resist**



#### **Solder Stencil**

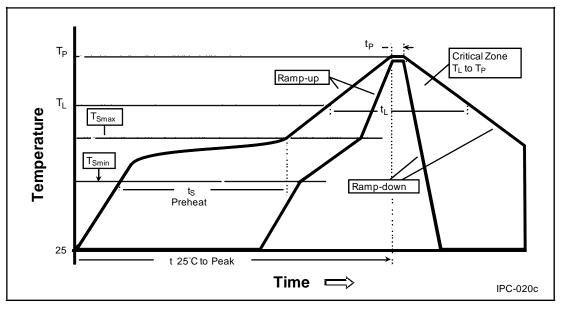


- All dimensions are in millimeters.
- Electrical isolation is required between Slug and Solder Pad.
- Recommended solder stencil thickness is 0.08mm



# **Reflow Soldering Condition**

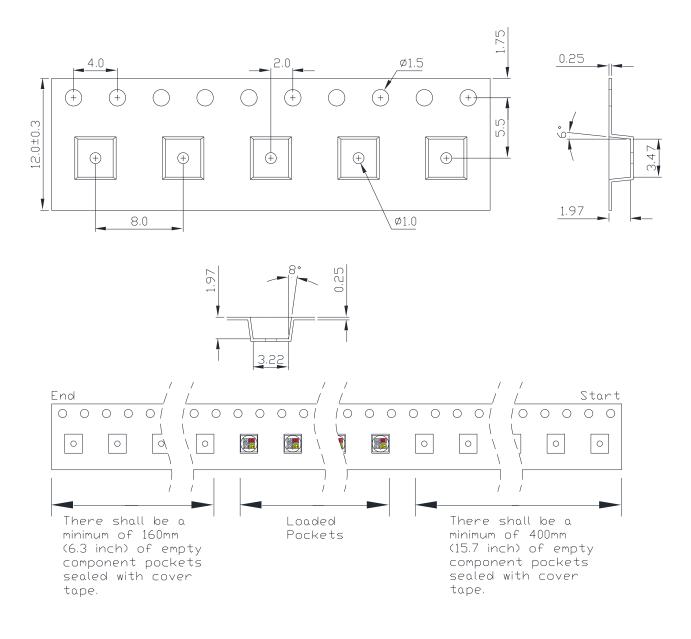
| Profile Feature                                   | Sn-Pb Eutectic Assembly | Pb-Free Assembly  |
|---|-------------------------|-------------------|
| Average Ramp-Up Rate                              | 3°C / second max.       | 3°C / second max. |
| (T <sub>Smax</sub> to T <sub>P</sub> )            |                         |                   |
| Preheat   |                         |                   |
| – Temperature Min (T <sub>Smin</sub> )            | 100°C                   | 150°C             |
| – Temperature Max (T <sub>Smax</sub> )            | 150°C                   | 200°C             |
| – Time (t <sub>smin</sub> to t <sub>smax</sub> )  | 60-120 seconds          | 60-180 seconds    |
| Time maintained above:                            |                         |                   |
| – Temperature (T <sub>L</sub> )                   | 183°C                   | 217°C             |
| – Time (t <sub>i</sub> )                          | 60-150 seconds          | 60-150 seconds    |
| Peak/Classification Temperature (T <sub>p</sub> ) | 240°C                   | 260°C             |
| Time Within 5°C of Actual Peak                    | 10-30 seconds           | 20-40 seconds     |
| Temperature (t <sub>p</sub> )                     |                         |                   |
| Ramp-Down Rate                                    | 6°C/second max.         | 6°C/second max.   |
| Time 25°C to Peak Temperature                     | 6 minutes max.          | 8 minutes max.    |



- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.



# **Emitter Reel Packaging**

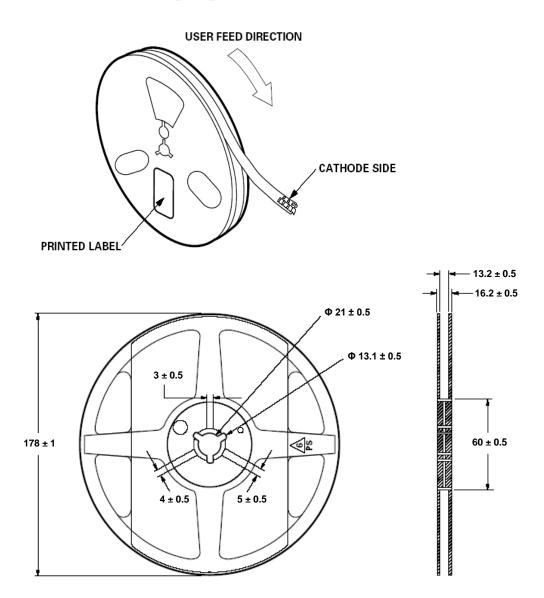


Notes:

- 1. Drawing not to scale.
- 2. All dimensions are in millimeters.
- 3. Unless otherwise indicated, tolerances are  $\pm\,0.1\text{mm}.$



# **Emitter Reel Packaging**



Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 500, 1000 pieces per reel.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.



# **Precaution for Use**

Storage

Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30 °C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseal the MBB.

- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- Electric Static Discharge (ESD) Protection The LEDs are STATIC SENSITIVE device. ESD protection or surge voltages shall be considered and taken care in the initial design stage, and whole production process. The following protection is recommended:

(1) A wrist band or an anti-electrostatic glove shall be used when handling the LEDs.(2) All devices, equipment and machinery must be properly grounded.

- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decide after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets. <u>http://www.prolightopto.com/</u>

# Handling of Lens LEDs

Notes for handling of lens LEDs

- Please do not use a force of over 1kgf impact or pressure on the lens, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the lens especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the lens.
- Please store the LEDs away from dusty areas or seal the product against dust.
- Please do not mold over the lens with another resin. (epoxy, urethane, etc)







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